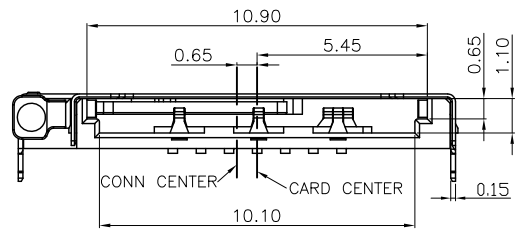
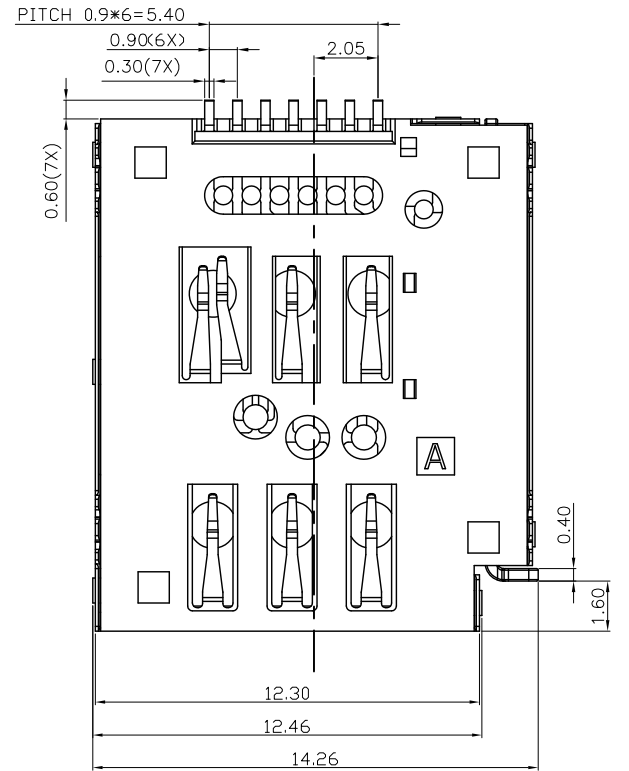
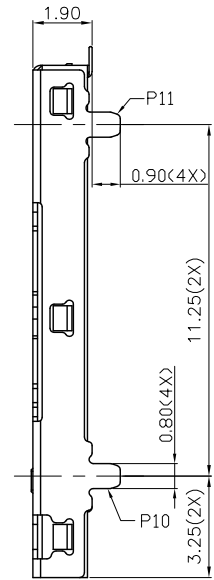
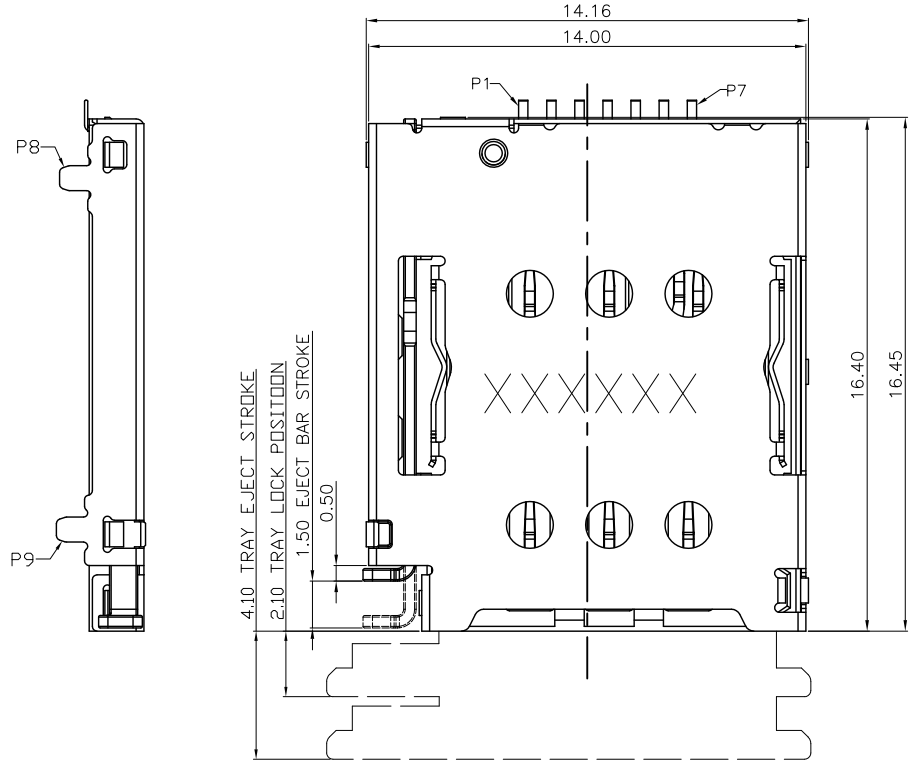
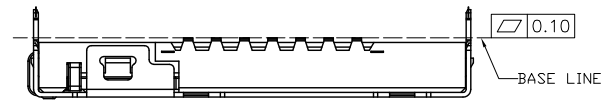


REV.	ECN.NO.	MODIFY.CONTENT

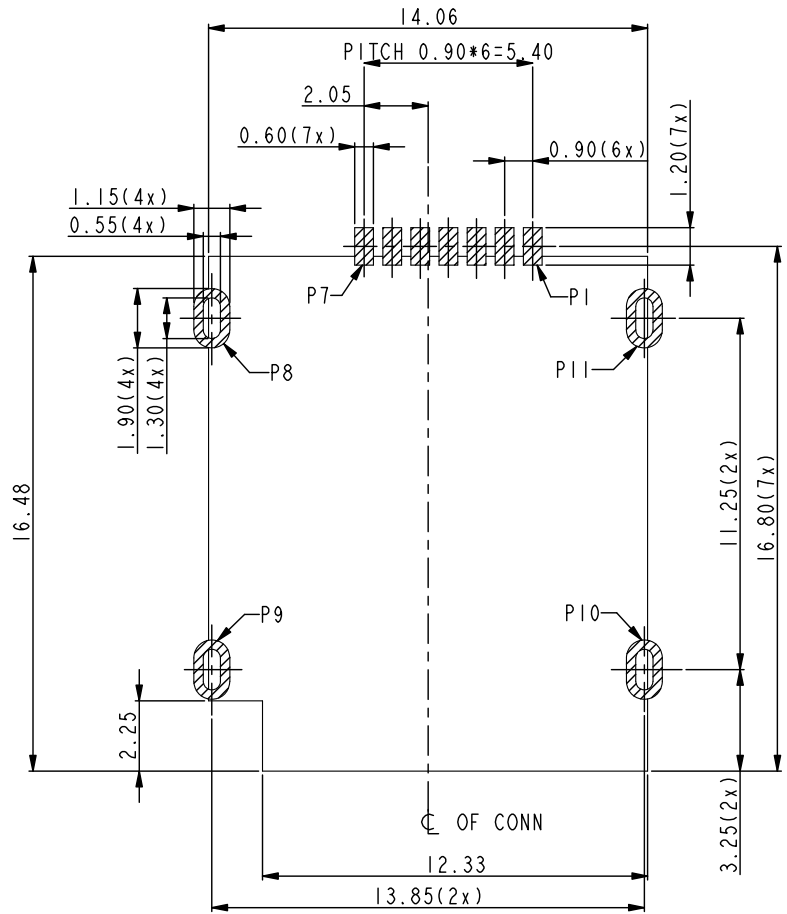
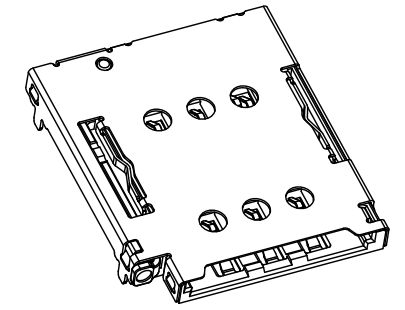


GENERAL TOLERANCE		DWG.NO.	SP188-AP401-00	PART.NO.	SP188-AP401-**	DRAWN	Ervin 2020.11.11
x.±0.50	x.*± 5°	REV.	A	TITLE	Nano SIM With Tray H1.90 conn.	CHECKED	
.x±0.25	.x*± 2°	SIZE		SHEET	1 OF 3	APPROVED	
.xx±0.15	.xx± 1°	A4					

UNIT	mm	SCALE	NO SCALE
<b>东莞市欧联电子科技有限公司</b> DONGGUAN OLN ELECTRONICS TECHNOLOGY CO., LTD.			

NOTES :

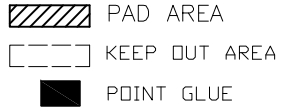
- MATERIAL :
  - HOUSING:LCP UL94 S475 V-0, BLACK COLOR.
  - SHELL:STAINLESS STEEL SUS304.
  - CONTACT:COPPER ALLOY C5210.
- FINISH :
  - CONTACT: GOLD PLATING ON CONTACT AREA, MATTE TIN 80u"MIN ON SOLDERTAIL AREA. 50u" MIN NICKEL PLATING OVERALL.
  - SHELL: 30U" MIN SOLDERABLE NICKEL PLATED OVER ALL.
- ELECTRICAL CHARACTERISTICS:
  - OPERATING VOLTAGE : 100V AC(rms)/DC.
  - CURRENT RATING : 0.5 A.
  - OPERATING TEMPERATURE: -25°C~+85°C.
  - CONTACT RESISTANCE: 100 m OHMS MAX.
  - INSULATION RESISTANCE: 1000M OHMS MIN. AT 250VDC.
  - DIELECTRIC WITHSTANDING VOLTAGE:500 VAC/1MINUTE.



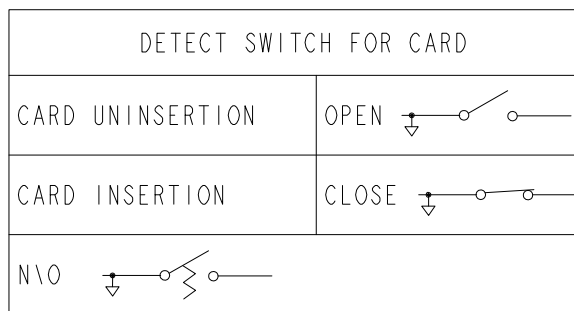
PART.NO.:  
 SP188-AP401-\*\*-\*\*

- 42: 功能 ?金1U",?????至少80U"
- 43: 功能 ?金3U",?????至少80U"
- 44: 功能 ?金5U",?????至少80U"
- 45: 功能 ?金10U",?????至少80U"
- 46: 功能 ?金15U",?????至少80U"
- 47: 功能 ?金30U",?????至少80U"

Recommended P.C.B LAYOUT  
 (TOP VIEW TOLERANCE±0.05)



OPEN/CLOSE OF SWITCH :



CONTACT PIN ASSIGNMENT		
PIN No.	No. FOR CARD	FUNCTION
P1	C5	GND
P2	CD	CARD DETECT
P3	C6	Vpp
P4	C1	Vcc
P5	C2	RST
P6	C7	I/O
P7	C3	CLK
P8	GND	GND
P9	GND	GND
P10	GND	GND
P11	GND	GND

GENERAL TOLERANCE		DWG.NO.	SP188-AP401-00	PART.NO.	SP188-AP401-**-**	DRAWN	Ervin 2020.11.11	UNIT	mm	SCALE	NO SCALE
x.±0.50	x.± 5°	REV.	A	TITLE	Nano SIM With Tray H1.90 conn.	CHECKED		东莞市欧联电子科技有限公司 DONGGUAN OLN ELECTRONICS TECHNOLOGY CO., LTD.			
.x±0.25	.x± 2°	SIZE		SHEET	2 OF 3	APPROVED					
.xx±0.15	.xx± 1°	A4									

# 东莞市欧联电子科技有限公司

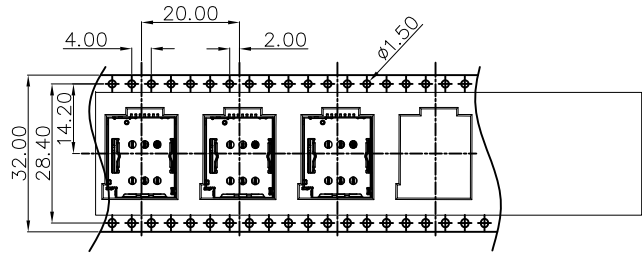
## 包装作业规范

REV.	ECN.NO.	MODIFY.CONTENT
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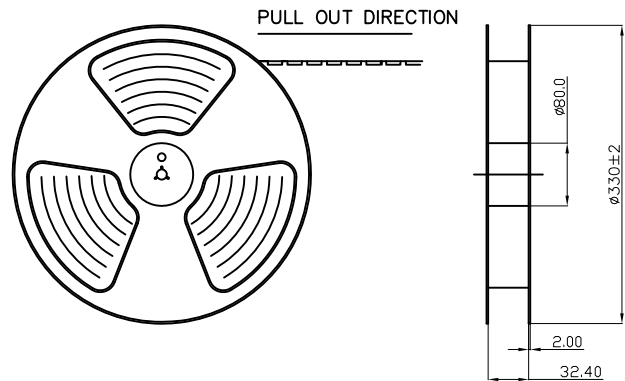
包装作业图示及说明

(PACKING OPERATION DIAGRAM & INSTRUCTION)

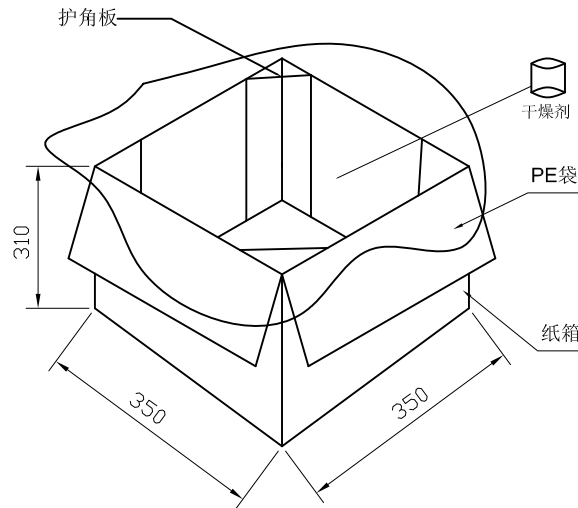
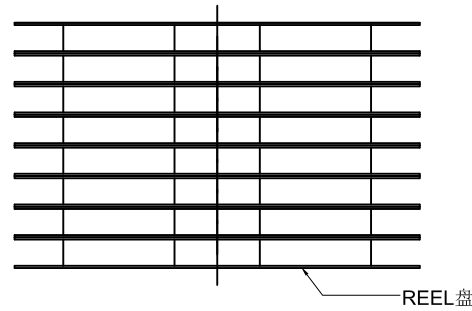
- 一.
- 1) 将成品一一放入REEL包装盘内,依同一方向放入.
  - 2) 包装时,如图所示.
  - 3) 一个REEL包装盘放置900个成品.



- 二.
- 1) 装盘前先把前面空20pcs产品,然后再开始装盘,尾端也需空20pcs产品,上带加长400mm.
  - 2) 装满成品的REEL包装盘如下图所示.



- 三.
- 1) 每箱装8盘REEL包装盘.
  - 2) 每箱放置7200 PCS的成品.



- 四.
- 1) 用TAPE将纸箱封实.

備註 (REMARK)

1. 若有未装满之零数箱,必须以缓冲材塞满.

GENERAL TOLERANCE	TOLERANCE	DWG.NO.	SP188-AP401-00	PART.NO.	SP188-AN401-**	DRAWN	Ervin 2020.11.11
x.±0.50	x.±5°	REV.	A	TITLE	Nano SIM With Tray H1.90 conn.	CHECKED	
.x±0.25	.x±2°	SIZE		SHEET	3 OF 3	APPROVED	
.xx±0.15	.xx±1°	A4					

UNIT	mm	SCALE	NO SCALE
东莞市欧联电子科技有限公司 DONGGUAN OLN ELECTRONICS TECHNOLOGY CO., LTD.			